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# 2SC4265

Silicon NPN Epitaxial

# HITACHI

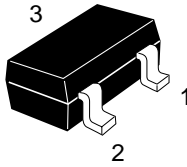
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## Application

VHF RF amplifier, Local oscillator, Mixer

## Outline

CMPAK



- 1. Emitter
- 2. Base
- 3. Collector

**Absolute Maximum Ratings** (Ta = 25°C)

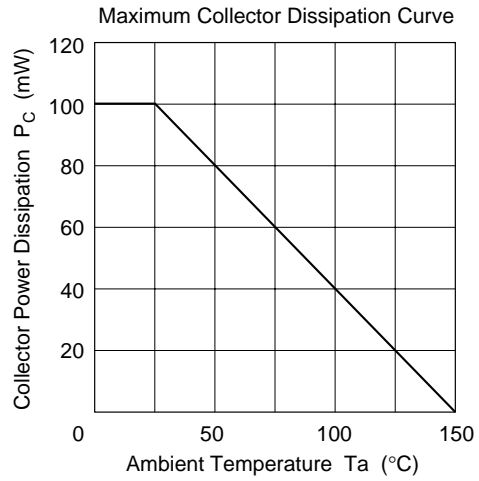
Item	Symbol	Ratings	Unit
Collector to base voltage	$V_{CBO}$	30	V
Collector to emitter voltage	$V_{CEO}$	20	V
Emitter to base voltage	$V_{EBO}$	3	V
Collector current	$I_C$	50	mA
Collector power dissipation	$P_C$	100	mW
Junction temperature	$T_j$	150	°C
Storage temperature	$T_{stg}$	-55 to +150	°C

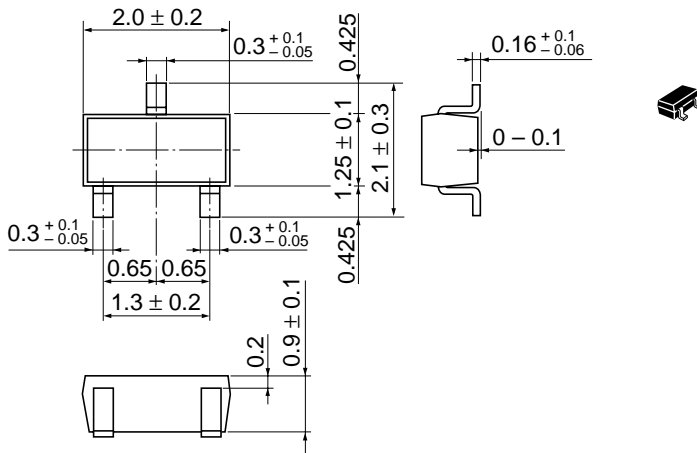
**Electrical Characteristics** (Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{(BR)CBO}$	30	—	—	V	$I_C = 10 \mu A, I_E = 0$
Collector to emitter breakdown voltage	$V_{(BR)CEO}$	20	—	—	V	$I_C = 1 \text{ mA}, R_{BE} = \infty$
Collector cutoff current	$I_{CBO}$	—	—	0.5	$\mu A$	$V_{CE} = 15 \text{ V}, I_E = 0$
Emitter cutoff current	$I_{EBO}$	—	—	10	$\mu A$	$V_{EB} = 3 \text{ V}, I_C = 0$
Collector to emitter saturation voltage	$V_{CE(sat)}$	—	—	1.0	V	$I_C = 20 \text{ mA}, I_B = 4 \text{ mA}$
DC current transfer ratio	$h_{FE}$	40	—	—		$V_{CE} = 10 \text{ V}, I_C = 10 \text{ mA}$
Collector output capacitance	$C_{ob}$	—	—	1.5	pF	$V_{CB} = 10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$
Gain bandwidth product	$f_T$	600	—	—	MHz	$V_{CE} = 10 \text{ V}, I_C = 10 \text{ mA}$

Note: Marking is "JC".

See characteristic curves of 2SC2735.





Hitachi Code	CMPAK
JEDEC	—
EIAJ	Conforms
Weight (reference value)	0.006 g

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